



# PDWS Nitrile Palm Dip ESD Wave Solder Low Heat

## **ESD Technical Bulletin**



## Electrostatic Decay in Combination with a Person

Standard: Rate of decay shall be less than 2.0 sec-

onds @12%RH

Found: +1kV to -100V Ave: 0.295 sec. -1kV to

-100V Ave: 0.304 sec.

Method: Mil-STD-3010C, 4046 (Modified)@

12%RH

# Café Glove Resistance in Combination with a Person

Target: Less than 1.0 x 10<sup>11</sup> ohms @12%RH

and 50%RH

Range: Min: 1.6 x 10<sup>6</sup> ohms

Max: 4.1 x 106 ohms

Method: ANSI/ESD SP15.1 @ 49.5%RH for 48

Hours

## **ESD Inside Shelf Life**

Requirement: 5 Years

Found: Indefinite for Storage Reference: Contains no Antistats

#### **Surface Resistance**

Target: Less than 1.0 x 10<sup>11</sup> ohms @12%RH

Range: Min: 2.4 x 10<sup>7</sup> ohms Max: 1.3 x 10<sup>8</sup> ohms

Method: ANSI/ESD STM11.11-2015 @

49.5%RH for 48 Hours

#### Surface Resistance

Target: Less than 1.0 x 10<sup>11</sup> ohms @12%RH

Range: Min: 3.6x 10<sup>7</sup> ohms Max: 7.1 x 10<sup>7</sup> ohms

Method: ANSI/ESD STM11.11-2015 @ 10.1%RH

for 48 Hours





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#### **Volume Resistance**

Standard: Less than 1.0 x 1011 ohms @12%RH

Min: 1.1 x 107 ohms Range: Max: 3.5 x 108 ohms

ANSI/ESD STM11.12-2015 @ Method:

49.5%RH for 48 Hours

#### **Volume Resistance**

Standard: Less than 1.0 x 1011 ohms @12%RH

Min: 5.8 x 107 ohms Range: Max: 8.8 x 108 ohms

ANSI/ESD STM11.12-2015 @ 10.1%RH Method:

for 48 Hours

Product Recommendations: The information presented herein is not guaranteed in any way, although to the best of QRP's knowledge and belief, it is true and accurate as of this date. Because the manner and conditions of use, handling, storage and other factors may involve a variety of safety, performance, or regulatory considerations unknown to QRP, users are responsible for determining the suitability of any QRP product for their specific purpose. QRP, Inc. does not warrant the results to be obtained in using any QRP product, and disclaims all liability with respect to the use, handling or further processing of any such product.

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